

WMP-SME-515



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10007397.022102

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By: J. P. ~

Date: 2/8/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Jenoe Tihanyi
Applic. No. : 10/007,397
Filed : October 22, 2001
Title : Semiconductor Component

P R E L I M I N A R Y A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

S i r :

Preliminary to examination, kindly amend the above-identified application as follows:

In the Translated Specification:

On ~~page~~ 1, line 1 through page 2, line 14, replace the paragraphs with:

-- SEMICONDUCTOR COMPONENT

Background of the Invention:

Field of the Invention: